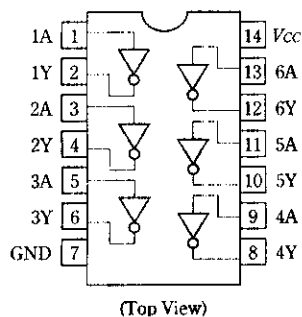


■ PIN ARRANGEMENT



■ ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Ratings	Unit
Supply voltage	V_{CC}	7.0	V
Input voltage	V_{IN}	7.0	V
Output voltage	V_{out}	30	V
Operating temperature range	T_{opr}	-20 ~ +75	°C
Storage temperature range	T_{stg}	-65 ~ +150	°C

■ RECOMMENDED OPERATING CONDITIONS

Item	Symbol	min	typ	max	Unit
Supply voltage	V_{CC}	4.75	5.00	5.25	V
High level output voltage	V_{OH}	-	-	30	V
Low level output current	I_{OL}	-	-	48	mA
Operating temperature range	T_{opr}	-20	25	75	°C

■ ELECTRICAL CHARACTERISTICS (Ta = -20 ~ +75°C)

Item	Symbol	Test Conditions	min	typ*	max	Unit	
Input voltage	V_{IH}		2.0	-	-	V	
	V_{IL}		-	-	0.8	V	
Output voltage	V_{OL}	$V_{CC} = 4.75V, V_{IH} = 2V$	$I_{OL} = 24mA$	-	-	0.4	V
			$I_{OL} = 48mA$	-	-	0.5	V
Input current	I_{IH}	$V_{CC} = 5.25V, V_I = 2.7V$	-	-	20	μA	
	I_{IL}	$V_{CC} = 5.25V, V_I = 0.4V$	-	-	-0.4	mA	
	I_I	$V_{CC} = 5.25V, V_I = 7V$	-	-	0.1	mA	
Output current	I_{OH}	$V_{CC} = 4.75V, V_{IL} = 0.8V, V_{OH} = 30V$	-	-	250	μA	
Supply current	I_{CCH}	$V_{CC} = 5.25V$	-	23	48	mA	
	I_{CCL}	$V_{CC} = 5.25V$	-	21	51	mA	
Input clamp voltage	V_{IK}	$V_{CC} = 4.75V, I_{IN} = -18mA$	-	-	-1.5	V	

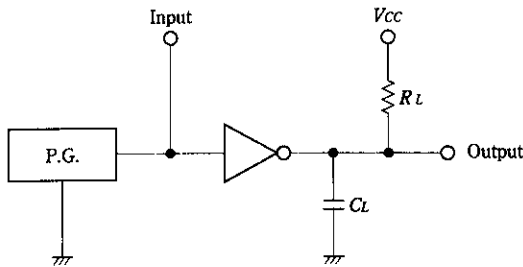
* $V_{CC} = 5V, T_a = 25^\circ C$

■ SWITCHING CHARACTERISTICS (Vcc = 5V, Ta = 25°C)

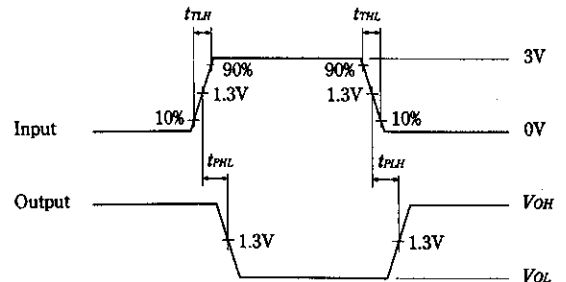
Item	Symbol	Test Conditions	min	typ	max	Unit
Propagation delay time	t_{PLH}	$C_L = 15pF, R_L = 110\Omega$	-	10	15	ns
	t_{PHL}		-	15	23	ns

■ TESTING METHOD

Test Circuit



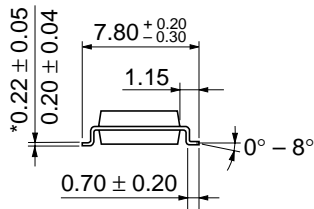
Waveform



- Notes) 1. Input pulse: PRR = 1MHz, duty cycle 50%, $Z_{out} = 50\Omega, t_{TLH} \leq 15ns, t_{THL} \leq 6ns$
 2. C_L includes probe and jig capacitance.
 3. All diodes are 1S2074(H)

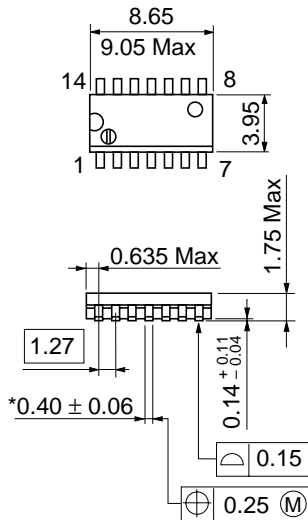


Hitachi Code	DP-14
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	0.97 g



Hitachi Code	FP-14DA
JEDEC	—
EIAJ	Conforms
Weight (reference value)	0.23 g

*Dimension including the plating thickness
Base material dimension



Hitachi Code	FP-14DN
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	0.13 g

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HITACHI

Hitachi, Ltd.

Semiconductor & Integrated Circuits.
Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan
Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

URL North America : <http://semiconductor.hitachi.com/>
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For further information write to:

Hitachi Semiconductor
(America) Inc.
179 East Tasman Drive,
San Jose, CA 95134
Tel: <1> (408) 433-1990
Fax: <1> (408) 433-0223

Hitachi Europe GmbH
Electronic components Group
Dornacher Straße 3
D-85622 Feldkirchen, Munich
Germany
Tel: <49> (89) 9 9180-0
Fax: <49> (89) 9 29 30 00

Hitachi Europe Ltd.
Electronic Components Group.
Whitebrook Park
Lower Cookham Road
Maidenhead
Berkshire SL6 8YA, United Kingdom
Tel: <44> (1628) 585000
Fax: <44> (1628) 778322

Hitachi Asia Pte. Ltd.
16 Collyer Quay #20-00
Hitachi Tower
Singapore 049318
Tel: 535-2100
Fax: 535-1533

Hitachi Asia Ltd.
Taipei Branch Office
3F, Hung Kuo Building, No.167,
Tun-Hwa North Road, Taipei (105)
Tel: <886> (2) 2718-3666
Fax: <886> (2) 2718-8180

Hitachi Asia (Hong Kong) Ltd.
Group III (Electronic Components)
7/F., North Tower, World Finance Centre,
Harbour City, Canton Road, Tsim Sha Tsui,
Kowloon, Hong Kong
Tel: <852> (2) 735 9218
Fax: <852> (2) 730 0281
Telex: 40815 HITEC HX

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